Graphene nanogaps for the directed assembly of single-nanoparticle devices Electronic Supplementary Information

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February 2021

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1 The Simmons Model



Figure S1: A trapezoidal tunnel barrier between a Left (L) and Right (R) electrode, separated by a distance d and an electrical bias V. Here, L and R are of the same material and at zero bias $\phi_L = \phi_R$.

An expression for the current density j flowing through a trapezoidal tunnel barrier of width $d = x_2 - x_1$ between two biased electrodes was derived by Simmons:¹

$$j = e \frac{4\pi m}{h^3} \int_0^\infty d\epsilon [f_L(\epsilon) - f_R(\epsilon)] \int_0^\epsilon d\epsilon_x T(\epsilon_x)$$
(S1)

where *m* is the electron mass, $f_{L,R}(\epsilon) = (e^{-(\epsilon - \mu_{L,R})/k_BT} + 1)^{-1}$ is the Fermi energy of the left and right leads, respectively, dependent on their chemical potential $\mu_{L,R}$, and $T(\epsilon_x)$ describes the transmission probability of an electron of energy ϵ_x through the tunnel barrier in the *x*-direction. An expression for $T(\epsilon_x)$ can be found by using the Wentzel-Kramers-Brillouin (WKB) approximation:

$$T(\epsilon_x) = e^{-\beta \int_{x_1}^{x_2} dx \sqrt{\phi(x) - \epsilon_x}}$$
(S2)

where $\beta = 2 \frac{\sqrt{2m}}{\hbar}$ and ϕ . If the work functions of the left and right leads are not equal, but change linearly from ϕ_L at x_1 to ϕ_R at x_2 as the a voltage V is applied symmetrically across the junction then we can write:

$$\phi_{L,R} = (1 \pm \alpha)\phi' \tag{S3}$$

where $\phi' = \frac{\phi_L - \phi_R}{2}$ is the average barrier height and $\alpha = \frac{\phi_L - \phi_R}{\phi_L + \phi_R}$ is an asymmetry factor, which are used for simplified fitting. Different analytical expressions for the integral $\int_{x_1}^{x_2} dx \sqrt{\phi(x) - \epsilon_x}$ can be found depending on the relative magnitudes of ϕ_L , ϕ_R and ϵ_x :²

if
$$\phi_{\mathrm{L,R}} < \epsilon_{\mathrm{x}} < \phi_{\mathrm{R,L}} : \int_{\mathrm{x}_1}^{\mathrm{x}_2} \mathrm{dx}\sqrt{\phi(\mathrm{x}) - \epsilon_{\mathrm{x}}} = \mathrm{d}\frac{2}{3} \frac{(\phi_{\mathrm{R,L}} - \epsilon_{\mathrm{x}})^{3/2}}{\phi_{\mathrm{R}} - \phi_{\mathrm{L}}}$$
 (S4)

else
$$\epsilon_{\rm x} < \phi_{\rm L}, \phi_{\rm R} : \int_{\rm x_1}^{\rm x_2} {\rm dx} \sqrt{\phi({\rm x}) - \epsilon_{\rm x}} = {\rm d}\frac{2}{3} \frac{(\phi_{\rm R} - \epsilon_{\rm x})^{3/2} - (\phi_{\rm L} - \epsilon_{\rm x})^{3/2}}{\phi_{\rm R} - \phi_{\rm L}}$$
 (S5)

In the low temperature limit where $k_BT \ll \mu_L, \mu_R, \phi(x)$ the Fermi distribution becomes a step function and (S1) becomes:

$$j = e \frac{4\pi m}{h^3} \int_{\mu_R}^{\mu_L} d\epsilon \int_0^\epsilon d\epsilon_x T(\epsilon_x)$$
(S6)

In order to fit (S6) to the measured current I we must multiply it by the cross sectional area A' of the junction such that I = A'j. However, A' is not independent of other variables such as the effective electron mass and so is incorporated into a prefactor $A = e \frac{4\pi m}{h^3} A'$. Current-voltage data can then be fitted to the model to (S7) to find ϕ' [eV], α , d [m] and A [eV⁻²].

$$I = A \int_{\mu_R}^{\mu_L} d\epsilon \int_0^\epsilon d\epsilon_x T(\epsilon_x)$$
(S7)

2 The Orthodox Model

Electron transport through a mesoscopic island separated by two tunnel barriers is well described by the classical 'orthodox' theory of correlated electron tunneling.^{3–5} This model does not consider any discreteness of the energy spectrum of the island. This is a particularly good approximation for metals where level spacing is negligible. The orthodox theory can be extended to consider the presence of quantised energy levels provided that k_BT is much greater than the intrinsic width of these levels, details of which can be found in ^{6,7}, but this will not be considered here.

Figure S2 shows an equivalent 2-terminal RC circuit model that the orthodox theory describes. The tunnel rates $\Gamma_{L,R}^{+,-}$ capture the rate at which electrons are added to/taken off the island from to/from the left/right electrodes, as indicated by the arrows. We can describe the associated addition/subtraction energies with each added/removed electron starting from an initial state of n electrons on the island as:

$$\Delta E_{\mathrm{L}}^{+}(n) = U(n+1) - U(n) + \eta e V_{b} \tag{S8}$$

$$\Delta E_{\rm L}^-(n) = U(n) - U(n-1) + \eta e V_b \tag{S9}$$

$$\Delta E_{\rm R}^+(n) = U(n+1) - U(n) - (1-\eta)eV_b \tag{S10}$$



Figure S2: A circuit diagram representing the orthodox model. Each tunnel barrier is represented by a RC circuit and electrons tunnel from (-)/to (+) the Left/Right electrodes at rate Γ . The central island has a residual fractional charge Q_0 .

$$\Delta E_{\rm B}^{-}(n) = U(n) - U(n-1) - (1-\eta)eV_b \tag{S11}$$

Where U(n) is the total energy of the island with n electrons, V_b is the bias voltage and η is the fraction of the voltage dropped over the left tunnel barrier. Within the limits of the model we can equivalently express these in electrostatic terms:

$$\Delta E_{\rm L}^{\pm}(n) = \Delta U^{\pm}(n) \pm \frac{eC_{\rm R}}{C_L + C_R} V_b \tag{S12}$$

$$\Delta E_{\rm R}^{\pm}(n) = \Delta U^{\pm}(n) \mp \frac{eC_{\rm L}}{C_L + C_R} V_b \tag{S13}$$

$$\Delta U^{\pm}(n) = \frac{(Q \pm e)^2}{2(C_L + C_R)} - \frac{Q^2}{2(C_L + C_R)}$$
(S14)

Where $Q = (ne - Q_0)$ is the total charge of the island before the electron tunnels and Q_0 is the fractional charge $(|Q_0| < e/2)$ present on the island at zero bias. We can then write:

$$\Delta E_{\rm L}^{\pm}(n) = \frac{e}{C_L + C_R} \left(\frac{e}{2} \pm \left((ne - Q_0) + C_{\rm R} V_b \right) \right)$$
(S15)

$$\Delta E_{\rm R}^{\pm}(n) = \frac{e}{C_L + C_R} \left(\frac{e}{2} \pm \left((ne - Q_0) - C_{\rm L} V_b \right) \right)$$
(S16)

The tunnelling rates across the left-side and right-side barriers can be obtained from a golden rule calculation 3 :

$$\Gamma_{L,R}^{\pm}(n) = \frac{1}{R_{L,R}e^2} \left(\frac{-\Delta E_{L,R}^{\pm}(n)}{1 - \exp\left(\Delta E_{L,R}^{\pm}(n)/k_BT\right)} \right)$$
(S17)

Where any dependence of $\Gamma_{L,R}^{\pm}$ on *n* itself has been neglected. The current through the island at a given bias voltage is then given by:

$$I(V_b) = e \sum_{n=-\infty}^{\infty} \sigma(n) \left[\Gamma_{\mathrm{R}}^+(n) - \Gamma_{\mathrm{R}}^-(n) \right] = e \sum_{n=-\infty}^{\infty} \sigma(n) \left[\Gamma_{\mathrm{L}}^-(n) - \Gamma_{\mathrm{L}}^+(n) \right]$$
(S18)

Here, $\sigma(n)$ describes the ensemble distribution of the number of electrons on the island: the probability that any one value of n electrons are on the island. Finding $\sigma(n)$ requires noting that the net probability for making a transition between any two adjacent states is zero under a steady state, giving:

$$\sigma(n) \left[\Gamma_{\rm L}^+(n) + \Gamma_{\rm R}^+(n) \right] = \sigma(n+1) \left[\Gamma_{\rm L}^-(n+1) + \Gamma_{\rm R}^-(n+1) \right]$$
(S19)

and by implementing the normalisation condition $\sum_{n=-\infty}^{\infty} \sigma(n) = 1$. Thus, we can solve for $\sigma(n)$ and thereby $I(V_b)$ numerically.

We can extend this theory to include the influence of a gate electrode at voltage V_g connected to the island by a capacitor C_G by modifying (S15) and (S16) to:

$$\Delta E_{\rm L}^{\pm}(n) = \frac{e}{C_{\Sigma}} \left(\frac{e}{2} \pm \left((ne - Q_0) + C_{\rm R} V_b - C_{\rm G} V_g \right) \right)$$
(S20)

$$\Delta E_{\rm R}^{\pm}(n) = \frac{e}{C_{\Sigma}} \left(\frac{e}{2} \pm \left((ne - Q_0) - (C_{\rm L} + C_{\rm G})V_b - C_{\rm G}V_g \right) \right)$$
(S21)

where $C_{\Sigma} = C_L + C_R + C_G$. From here the derivation of the current follows the same process as above.

3 Thermally Broadened Peaks

From Beenakker,⁷ in the classical limit of $h\Gamma$, $\Delta E \ll k_B T \ll e^2/CE$ the lineshape of the Coulomb blockade resonances is given by:

$$G/G_{max} \approx \cosh^{-2}\left(\frac{\beta e|V_g - V_0|}{2.5k_BT}\right)$$
 (S22)

where β is the capacitive coupling to the gate, V_g is the gate voltage and V_0 is the voltage at which the resonance is centred.

4 Electric Field Calculations

The electric field distribution in our graphene devices was modelled using the finite element method in COMSOL Multiphysics 5.5 using the electric currents interface from the AC/DC physics module which computes electric fields and



Figure S3: Schematics of the geometries used for electric field calculations for: (a) A 2 nm graphene nanogap with a floating buried gate, (b) a single graphene electrode trapping against a buried gate and (c) a 20 nm gold electrode trapping against a buried gate.

potential distributions for conducting media where inductive effects can be neglected. The model was solved in the frequency domain at $\omega = 1$ MHz. In this interface Poisson's equation is expressed as:

$$\nabla \cdot \mathbf{J} = Q = -\partial \rho / \partial t \tag{S23}$$

$$\mathbf{J} = \sigma \mathbf{E} + j\omega \mathbf{D} \tag{S24}$$

$$\mathbf{E} = -\nabla\varphi \tag{S25}$$

The simulation domain was built as shown in Figure S3a. The citrate solution was assumed to have a permittivity of 80 and was found to have a conductivity of 600 μ S cm⁻¹. The HfO₂ was assigned a permittivity of 13⁻⁸ and a negligible conductivity. Dirichlet boundary conditions of $\varphi = 0.75$ and $\varphi = 0$ were set on the left and right vertices of the graphene layer at the edges of the simulation domain, respectively. The buried gate electrode was assigned a 'floating potential' boundary condition. All other external boundaries were set to an insulating Neumann boundary condition $\mathbf{n} \cdot \mathbf{J} = 0$. At the graphene layer a dielectric shielding boundary condition was used whereby:

$$\mathbf{n} \cdot (\mathbf{J}_1 - \mathbf{J}_2) = -\nabla_T \cdot d_s d((\sigma + j\omega\varepsilon_0\varepsilon_r)\nabla_T\varphi)$$
(S26)

where **n** is the normal vector, $\mathbf{J}_{1,2}$ are the current densities on either side of the boundary, ∇_T is the tangential differential, d_s is the thickness of the boundary which was set as 1 nm. We used $\varepsilon_r = 6.9^{-9}$ and set the conductivity as $\sigma = e\mu_e n_{2D}(\varphi(x))$, where μ_e is the electron mobility in graphene (2.5 × 10⁴ cm²V⁻¹s⁻¹) and n_{2D} is the surface charge concentration per unit area. This was defined according to the analytical expression presented by Barik *et al.*:¹¹

$$n_{2D}(\varphi(x)) = 2\frac{\Gamma(2)}{\pi} \left(\frac{k_B T}{\hbar\nu_F}\right)^2 \left[\mathcal{F}_1(\frac{e\varphi(x)}{k_B T}) - \mathcal{F}_1(\frac{-e\varphi(x)}{k_B T})\right]$$
(S27)

where ν_F is the Fermi velocity (10⁶ ms⁻¹ in graphene), $\varphi(x)$ is the electric potential at position x in the graphene layer and \mathcal{F}_1 is the Fermi-Dirac integral of order 1:

$$\mathcal{F}_j = \frac{1}{\Gamma(j+1)} \int_0^\infty \frac{\epsilon^j d\epsilon}{e^{\epsilon-\eta} + 1}$$
(S28)

where $\eta = \pm/k_B T$ and $\Gamma(n) = (n-1)!$. $n_{2D}(x)$ was calculated in MATLAB using the algorithm published by Wang and Lundstrom,¹² which was then used by COMSOL in a self-consistent calculation for φ .

The calculations for a single graphene electrode trapping against a local gate electrode were configured in much the same way, except that the gate electrode was assigned a Dirichlet boundary condition of $\varphi = V_g = 0.75$ and the left electrode was removed. This is shown in Figure S3b. For the gold electrode a 20 nm high, rounded geometry was used, and the potential difference was again applied between the buried gate and the right electrode as shown in Figure S3c. The gold was assigned a conductivity of $4.6 \times 10^7 \,\mathrm{S \, cm^{-1}}^{13}$ and a permittivity of 1.

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